L	Hits	Search Text	DB	Time stamp
Number				
1	274	(439/326).CCLS.	USPAT;	2004/08/06
			US-PGPUB;	16:43
			EPO; JPO;	1
			DERWENT;	
			IBM TDB	
2	180	(439/325).CCLS.	USPAT;	2004/08/06
			US-PGPUB;	16:14
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
3	176	(439/328).CCLS.	USPAT;	2004/08/06
			US-PGPUB;	16:21
Ξ.			EPO; JPO;	
			DERWENT;	
			IBM TDB	
4	13	(card near connector) and (metal near	USPAT;	2004/08/06
		guide) and faste\$4	US-PGPUB;	16:24
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
5	6	(card near connector) and (metal near	USPAT;	2004/08/06
		guide) and solder\$3	US-PGPUB;	16:41
			EPO; JPO;	ŀ
			DERWENT;	
			IBM TDB	
6	7	(card near connector) and (metal near	USPAT;	2004/08/06
	:	guid\$3) and solder\$3	US-PGPUB;	16:41
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
7	11	(USPAT;	2004/08/06
		plate same metal same guid\$3) and	US-PGPUB;	16:42
		solder\$3	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
8	199	(439/327).CCLS.	USPAT;	2004/08/06
			US-PGPUB;	16:43
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	